# NZ9F2V4ST5G, SZNZ9F2V4ST5G SERIES

# **Zener Voltage Regulators**

### 250 mW SOD-923 Surface Mount

This series of Zener diodes is packaged in a SOD-923 surface mount package. They are designed to provide voltage regulation protection and are especially attractive in situations where space is at a premium. They are well suited for applications such as cellular phones, hand held portables, and high density PC boards.

#### **Specification Features**

- Standard Zener Breakdown Voltage Range -2.4 V to 18 V
- Steady State Power Rating of 250 mW
- Small Body Outline Dimensions:
   0.039" x 0.024" (1.00 mm x 0.60 mm)
- Low Body Height: 0.016" (0.40 mm)
- ESD Rating of Class 3 (>16 kV) per Human Body Model
- Tight Tolerance V<sub>Z</sub>
- SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These are Pb-Free Devices

#### **Mechanical Characteristics**

**CASE:** Void-free, transfer-molded, thermosetting plastic

Epoxy Meets UL 94, V-0

**LEAD FINISH:** 100% Matte Sn (Tin)

**MOUNTING POSITION:** Any

QUALIFIED MAX REFLOW TEMPERATURE: 260°C

Device Meets MSL 1 Requirements

#### **MAXIMUM RATINGS**

Rating	Symbol	Max	Unit
Total Device Dissipation FR–5 Board, (Note 1) @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	250 2.0	mW mW/°C
Thermal Resistance from Junction–to–Ambient	$R_{\theta JA}$	500	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C

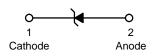
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

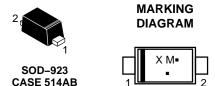
1. FR-4 Minimum Pad.



### ON Semiconductor®

#### http://onsemi.com





X = Specific Device Code

M = Month Code

= Pb-Free Package

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

Device	Package	Shipping†
NZ9FxxxST5G, SZNZ9FxxxST5G	SOD-923 (Pb-Free)	8000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **DEVICE MARKING INFORMATION**

See specific marking information in the device marking column of the Electrical Characteristics table on page 3 of this data sheet.

## NZ9F2V4ST5G, SZNZ9F2V4ST5G SERIES

### **ELECTRICAL CHARACTERISTICS**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted,})$ 

 $V_F = 0.9 \text{ V Max.} @ I_F = 10 \text{ mA for all types})$ 

	, ,,
Symbol	Parameter
VZ	Reverse Zener Voltage @ I <sub>ZT</sub>
I <sub>ZT</sub>	Reverse Current
Z <sub>ZT</sub>	Maximum Zener Impedance @ I <sub>ZT</sub>
I <sub>ZK</sub>	Reverse Current
Z <sub>ZK</sub>	Maximum Zener Impedance @ I <sub>ZK</sub>
I <sub>R</sub>	Reverse Leakage Current @ V <sub>R</sub>
V <sub>R</sub>	Reverse Voltage
IF	Forward Current
V <sub>F</sub>	Forward Voltage @ I <sub>F</sub>
ΘVZ	Maximum Temperature Coefficient of V <sub>Z</sub>
С	Max. Capacitance @V <sub>R</sub> = 0 and f = 1 MHz

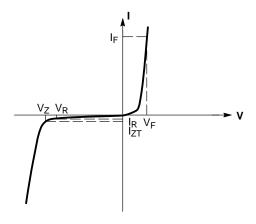


Figure 1. Zener Voltage Regulator

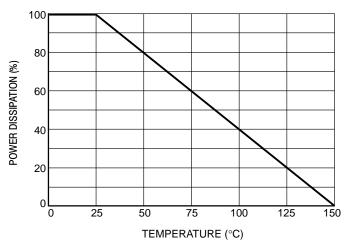


Figure 2. Steady State Power Derating

### NZ9F2V4ST5G, SZNZ9F2V4ST5G SERIES

**ELECTRICAL CHARACTERISTICS** ( $V_F = 0.9 \text{ Max} @ I_F = 10 \text{ mA}$  for all types)

		Zener \	_	Test	Z <sub>ZT</sub> I <sub>Z</sub> = IZT @ 10%	Z <sub>ZK</sub> I <sub>Z</sub> = 1.0		Ma IR @		d <sub>VZ</sub> /dt @ I <sub>ZT1</sub>		CpF Max @
Device***	Device Marking	Min	Max	Current Izt mA	$\begin{array}{c} \operatorname{Mod} \Omega \\ \operatorname{Max} \end{array}$	mA Ω Max	I <sub>ZK</sub> mA	μА	v	Min	Max	V <sub>R</sub> = 0 f = 1 MHz
SZ, NZ9F2V4ST5G	2*	2.43	2.63	5	100	1000	1	50	1	-3.5	0	210
SZ, NZ9F2V7ST5G	3*	2.67	2.91	5	100	1000	1	20	1	-3.5	0	210
SZ, NZ9F3V0ST5G	4*	2.94	3.26	5	100	1000	1	10	1	-3.5	0	210
SZ, NZ9F3V3ST5G	5*	3.32	3.53	5	100	1000	1	10	1	-3.5	0	210
SZ, NZ9F3V6ST5G	6*	3.6	3.85	5	100	1000	1	10	1	-3.5	0	210
SZ, NZ9F3V9ST5G	A**	3.89	4.16	5	100	1000	1	5	1	-3.5	-2.5	210
SZ, NZ9F4V3ST5G	D**	4.17	4.43	5	100	1000	1	5	1	-3.5	0	210
SZ, NZ9F4V7ST5G	E**	4.55	4.75	5	100	800	0.5	2	1	-3.5	0.2	150
SZ, NZ9F5V1ST5G	F**	4.989	5.2	5	80	500	0.5	2	1.5	-2.7	1.2	130
SZ, NZ9F5V6ST5G	J**	5.49	5.73	5	60	200	0.5	1	2.5	-2.0	2.5	115
SZ, NZ9F6V2ST5G	K**	6.06	6.33	5	60	100	0.5	1	3	0.4	3.7	110
SZ, NZ9F6V8ST5G	L**	6.65	6.93	5	40	60	0.5	0.5	3.5	1.2	4.5	105
SZ, NZ9F7V5ST5G	P**	7.28	7.6	5	30	60	0.5	0.5	4	2.5	5.3	100
SZ, NZ9F8V2ST5G	Q**	8.02	8.36	5	30	60	0.5	0.5	5	3.2	6.2	90
SZ, NZ9F9V1ST5G	R**	8.85	9.23	5	30	60	0.5	0.5	6	3.8	7	80
SZ, NZ9F10VST5G	T**	9.77	10.21	5	30	60	0.5	0.1	7	4.5	8	80
SZ, NZ9F11VST5G	V**	10.76	11.22	5	30	60	0.5	0.1	8	5.4	9	80
SZ, NZ9F12VST5G	Y**	11.74	12.24	5	30	80	0.5	0.1	9	6	10	80
SZ, NZ9F13VST5G	2**	12.91	13.49	5	37	80	0.5	0.1	10	7	11	75
SZ, NZ9F15VST5G	3**	14.34	14.98	5	42	80	0.5	0.1	11	9.2	13	70
SZ, NZ9F16VST5G	4**	15.85	16.51	5	50	80	0.5	0.1	12	10.4	14	65
SZ, NZ9F18VST5G	5**	17.56	18.35	5	50	80	0.5	0.1	14	12.4	16	60

<sup>\*</sup>Rotated 90°.

\*\*Rotated 180°.

\*\*Rotated 180°.

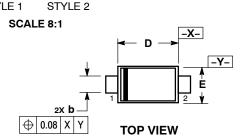
\*\*\*SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable.

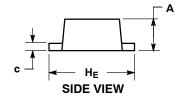


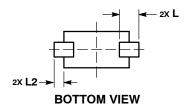


SOD-923 CASE 514AB ISSUE D

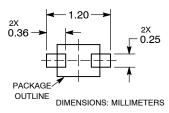
**DATE 03 SEP 2020** 







#### **SOLDERING FOOTPRINT\***



See Application Note AND8455/D for more mounting details

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

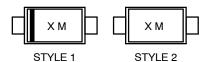
- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
  3. MAXIMUM LEAD THICKNESS INCLUDES LEAD MAXIMUM LEAD I HICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

   DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

   DIMENSION L WILL NOT EXCEED 0.30mm.

	MIL	LIMETE	ERS	INCHES			
DIM	MIN	NOM	MAX	MIN	MOM	MAX	
Α	0.34	0.37	0.40	0.013	0.015	0.016	
b	0.15	0.20	0.25	0.006	800.0	0.010	
С	0.07	0.12	0.17	0.003	0.005	0.007	
D	0.75	0.80	0.85	0.030	0.031	0.033	
Е	0.55	0.60	0.65	0.022	0.024	0.026	
HE	0.95	1.00	1.05	0.037	0.039	0.041	
L	(	).19 REI	F	0.007 REF			
L2	0.05	0.10	0.15	0.002	0.004	0.006	

#### **GENERIC MARKING DIAGRAM\***



Χ = Specific Device Code

= Date Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

STYLE 2: NO POLARITY STYLE 1: PIN 1. CATHODE (POLARITY BAND) 2. ANODE

DOCUMENT NUMBER:	98AON23284D	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	SOD-923, 1.0X0.6X0.37, MAX HEIGHT 0.40		PAGE 1 OF 1	

ON Semiconductor and (III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

ON Semiconductor and the are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor and see no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and

#### **PUBLICATION ORDERING INFORMATION**

LITERATURE FULFILLMENT:
Email Requests to: orderlit@onsemi.com

ON Semiconductor Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative